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SCH1337

Power MOSFET
–30V, 150mΩ, –2A, Single P-Channel

ON Semiconductor®

www.onsemi.com

This Low-profile High-power MOSFET is produced using ON Semiconductor's trench technology, which is specifically designed to minimize gate charge and ultra low on resistance. This device is suitable for applications with low gate charge driving or ultra low on resistance requirements.

Features

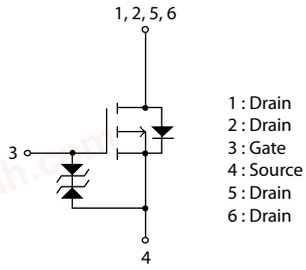
- Low On-Resistance
- 4V drive
- Pb-Free, Halogen Free and RoHS compliance
- Ultra small package SCH6 (1.6mm×1.6mm×0.56mmt)

Typical Applications

- LCD Driver
- Load Switch
- Voltage Protection

V_{DSS}	R_{DS}(on) Max	I_D Max
–30V	150mΩ@ –10V	–2A
	255mΩ@ –4.5V	
	292mΩ@ –4V	

ELECTRICAL CONNECTION
P-Channel



SPECIFICATIONS

ABSOLUTE MAXIMUM RATING at Ta = 25°C (Note 1)

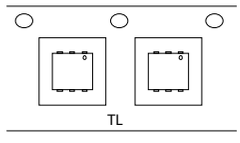
Parameter	Symbol	Value	Unit
Drain to Source Voltage	V_{DSS}	–30	V
Gate to Source Voltage	V_{GSS}	±20	V
Drain Current (DC)	I_D	–2	A
Drain Current (Pulse) PW ≤ 10μs, duty cycle ≤ 1%	I_{DP}	–8	A
Power Dissipation When mounted on ceramic substrate (900mm^2× 0.8mm)	P_D	0.8	W
Junction Temperature	Tj	150	°C
Storage Temperature	Tstg	–55 to +150	°C

Note 1 : Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

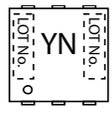
2 : This product is designed to "ESD immunity<200V*", so please take care when handling.

*Machine Model

PACKING TYPE : TL



MARKING



ORDERING INFORMATION

See detailed ordering and shipping information on page 5 of this data sheet.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Value	Unit
Junction to Ambient When mounted on ceramic substrate (900mm^2× 0.8mm)	$R_{\theta JA}$	156.2	°C/W

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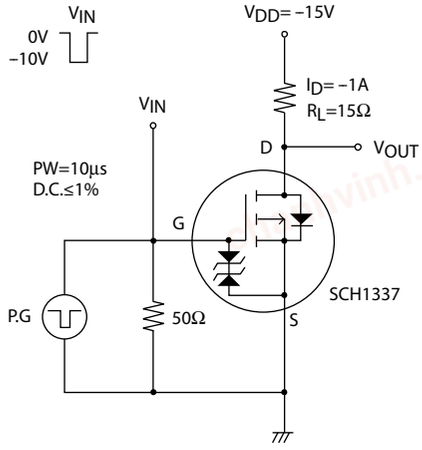
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ELECTRICAL CHARACTERISTICS at Ta = 25°C (Note 3)

Parameter	Symbol	Conditions	Value			Unit
			min	typ	max	
Drain to Source Breakdown Voltage	$V_{(BR)DSS}$	I_D=–1mA, V_{GS}=0V	–30			V
Zero-Gate Voltage Drain Current	I_{DSS}	V_{DS}=–30V, V_{GS}=0V			–1	μA
Gate to Source Leakage Current	I_{GSS}	V_{GS}=±16V, V_{DS}=0V			±10	μA
Gate Threshold Voltage	$V_{GS}(th)$	V_{DS}=–10V, I_D=–1mA	–1.2		–2.6	V
Forward Transconductance	g_{FS}	V_{DS}=–10V, I_D=–1A		1.9		S
Static Drain to Source On-State Resistance	$R_{DS}(on)1$	I_D=–1A, V_{GS}=–10V		115	150	mΩ
	$R_{DS}(on)2$	I_D=–0.5A, V_{GS}=–4.5V		182	255	mΩ
	$R_{DS}(on)3$	I_D=–0.5A, V_{GS}=–4V		208	292	mΩ
Input Capacitance	Ciss	V_{DS}=–10V, f=1MHz		172		pF
Output Capacitance	Coss			51		pF
Reverse Transfer Capacitance	Crss			36		pF
Turn-ON Delay Time	$t_d(on)$	See specified Test Circuit		4.5		ns
Rise Time	t_r			4.2		ns
Turn-OFF Delay Time	$t_d(off)$			20		ns
Fall Time	t_f			10.6		ns
Total Gate Charge	Qg	V_{DS}=–15V, V_{GS}=–10V, I_D=–2A		3.9		nC
Gate to Source Charge	Qgs			0.6		nC
Gate to Drain “Miller” Charge	Qgd			0.8		nC
Forward Diode Voltage	V_{SD}	I_S=–2A, V_{GS}=0V		–0.86	–1.5	V

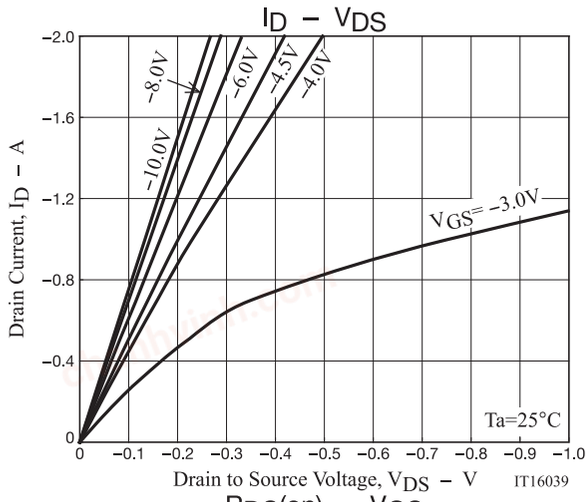
Note 3 : Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

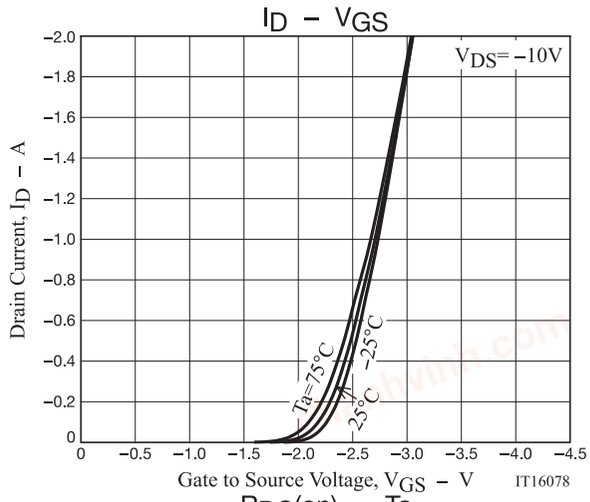
Switching Time Test Circuit

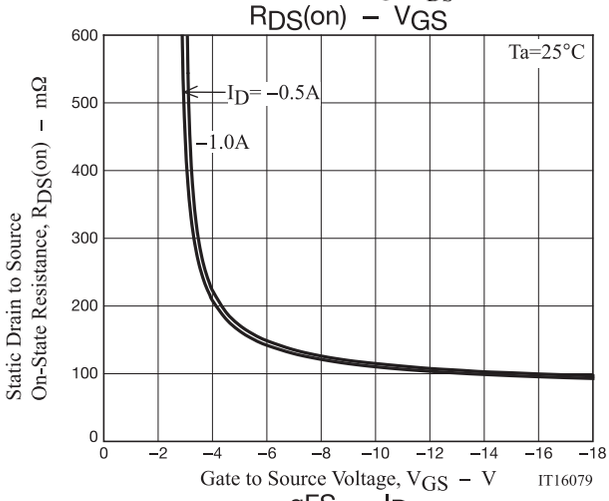


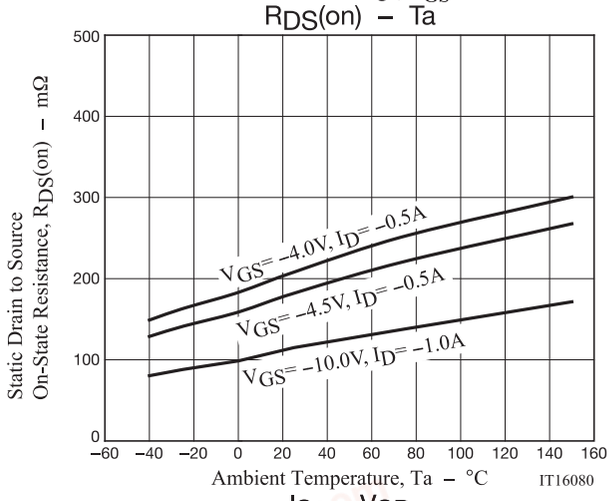
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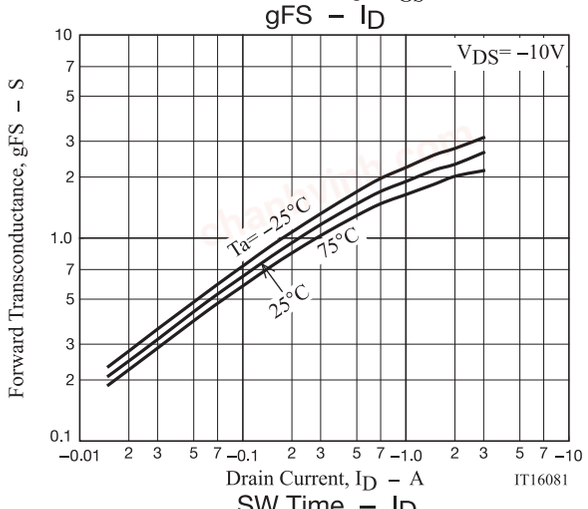
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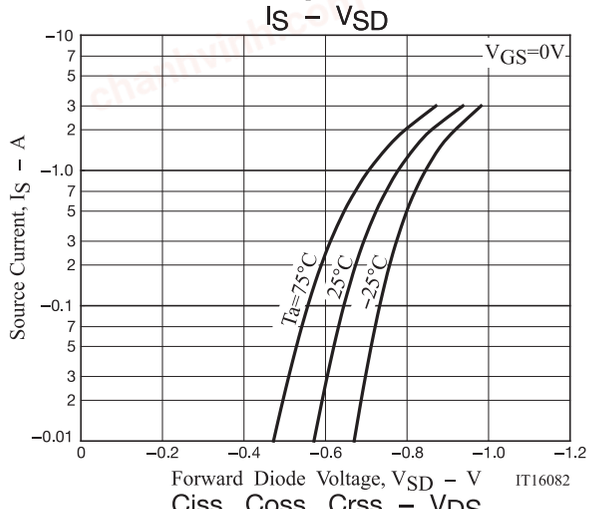


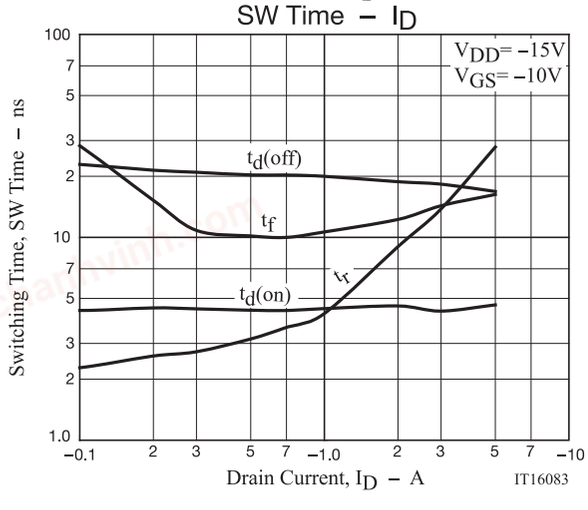


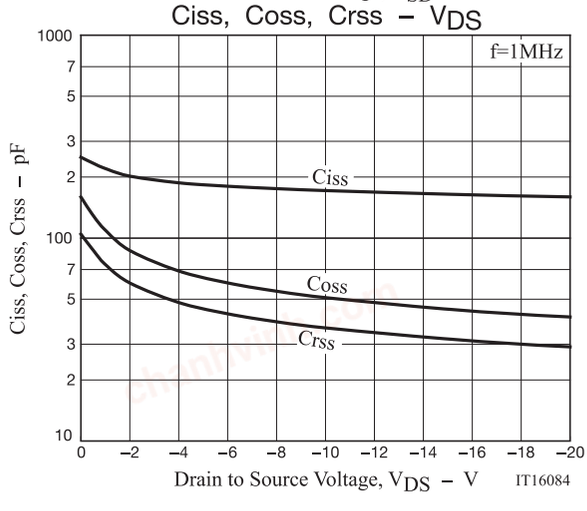




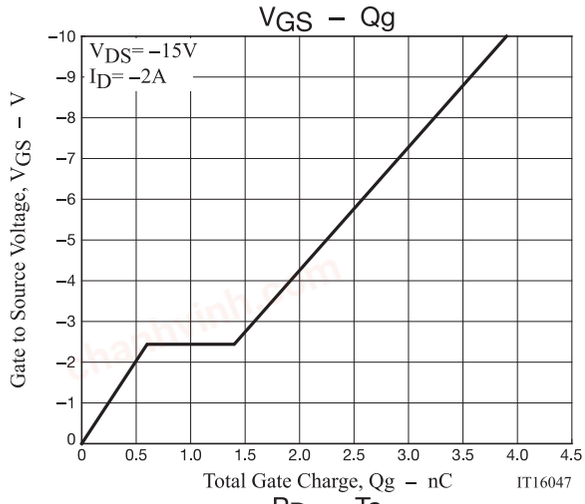


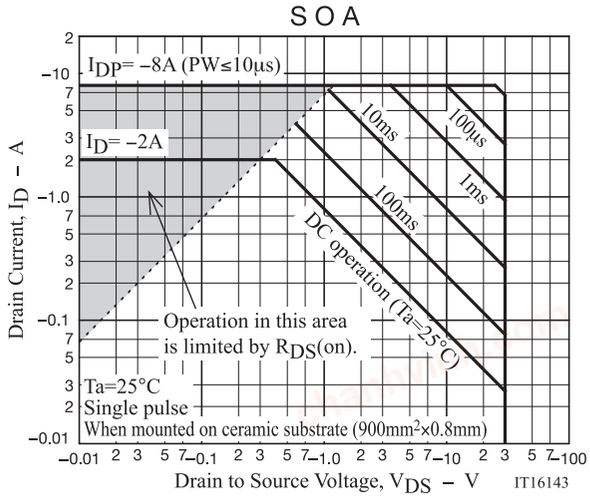


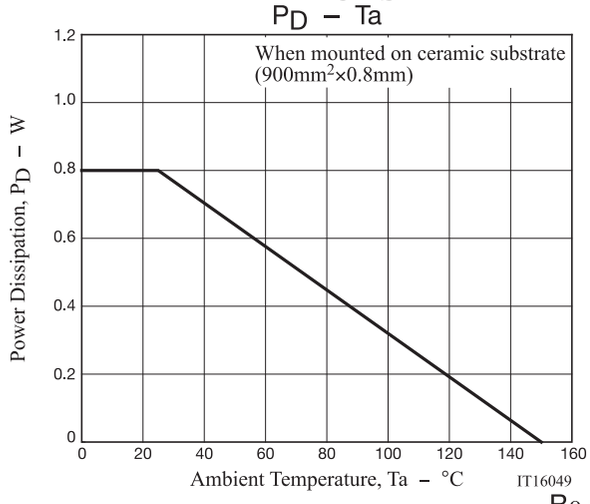


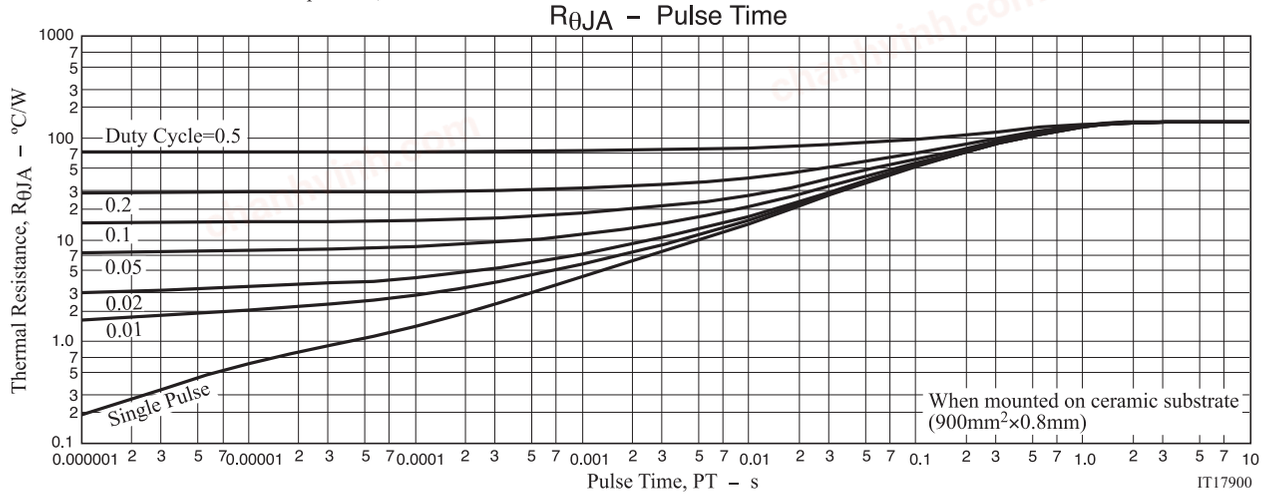


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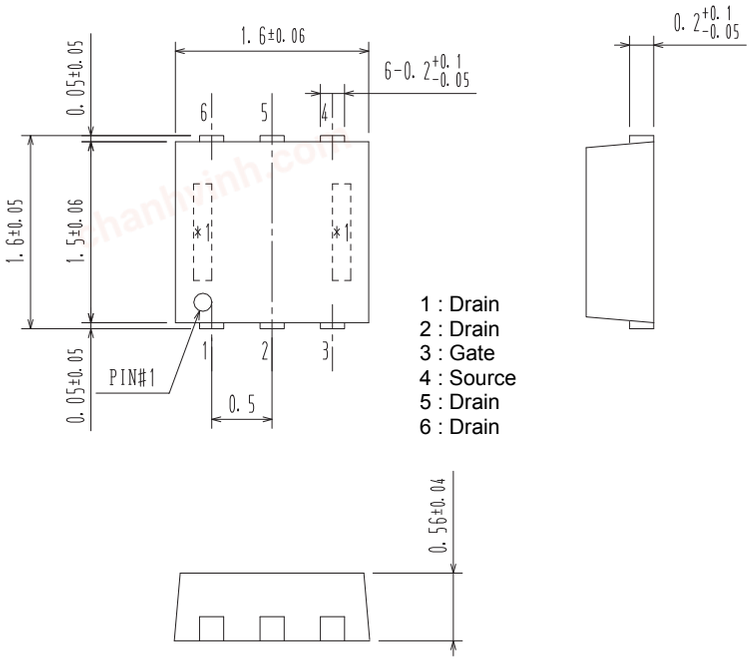
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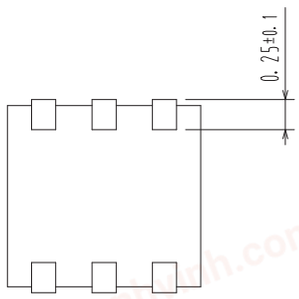
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PACKAGE DIMENSIONS

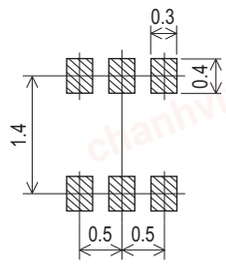
unit : mm

SOT-563 / SCH6
CASE 463AB
ISSUE O





Recommended Soldering Footprint



ORDERING INFORMATION

Device	Marking	Package	Shipping (Qty / Packing)
SCH1337-TL-H	YN	SOT-563 / SCH6 (Pb-Free / Halogen Free)	5,000 / Tape & Reel
SCH1337-TL-W			

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. http://www.onsemi.com/pub_link/Collateral/BRD8011-D.PDF

Note on usage : Since the SCH1337 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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